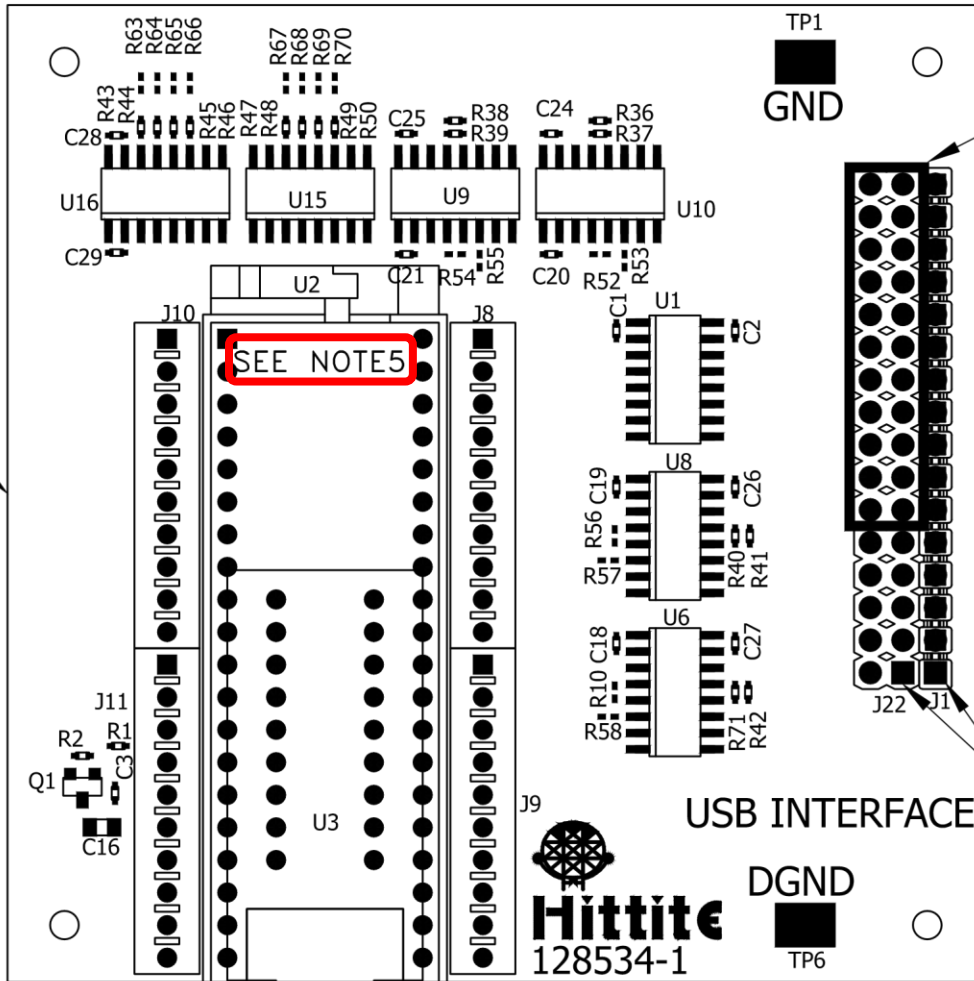


DO NOT SCALE PRINT

REVISION				
ZONE	LTR	DESCRIPTION	DATE	APPROVED
1		ENGINEERING RELEASE	01/21/14	D. ACEVAL
A		PRODUCTION RELEASE CP150501	04/21/15	D. ACEVAL
B		CHANGE AS PER CP190213	04/25/19	D. ACEVAL



SEE NOTE 4

NOTES:

1. SOLDER QUALITY TO IPC-A 610, CLASS 2.
2. MANUALLY DISPENSE SOLDER (ITEM 4) FOR ALL COMPONENTS.
3. OBSERVE POLARIZED COMPONENTS.
4. INSTALL J22 (2 X 11, BOTTOM SIDE) AS SHOWN IN HIGHLIGHTED AREA WITH SHORT SIDE OF PINS FACING UP
5. DLP-2232H REMOVE SHUNT FROM JP2 ON USB MODULE AND PLACE ON JP1 BEFORE USING

PCB
1

TOP VIEW



CAUTION!: THIS ASSEMBLY CONTAINS DEVICES THAT ARE CLASS 1A SENSITIVE TO ELECTROSTATIC DISCHARGE AND EXTREME CARE MUST BE EXERCISED. HANDLING SHALL BE PER ANSI/ESD S20.20

PROPRIETARY TO HITTITE MICROWAVE CORPORATION

DRAWN:
D. ACEVAL 01/21/2014
CHECKED:
ENG. APPD:
DON YOUNG
APPD:
RELEASED:



HITTITE MICROWAVE CORPORATION
20 Alpha Road
Chelmsford, MA 01824

TITLE
AD, USB I/F WITH PAR. I/O

SIZE	CODE ID NO.	DRAWING NO.	REV
B		115-01052-00	B
SCALE: NTS	WT	SHEET: 1 OF 1	